

## SPICE Modeling Report

# 4.5 V to 28 V Input, 1.0 A Integrated MOSFET Single Synchronous Buck DC/DC Converter

## BD9E105FP4-Z

### General Description

In this report, the characteristics that can be confirmed by the simulation using the SPICE model of the regulator IC BD9E105FP4-Z will be described.

### Simulation Environment

- Circuit Simulator : PSpice / Cadence Design System, Inc.
- Version Information : 17.2-2016
- OS Information : Windows 10 64-bit Edition
- Target Datasheet : TSZ02201-0T7T0AJ01560-1-2

### File Information

- Library File Name : BD9E105FP4-Z\_PSpice.lib
- Symbol File Name : BD9E105FP4-Z\_PSpice.olb
- Subcircuit and Symbol

**Table 1 Correspondence Table**

Product Name	Subcircuit	Symbol
BD9E105FP4-Z	BD9E105FP4Z (Model for Transient Analysis)	BD9E105FP4-Z
	BD9E105FP4Z_AVE <sup>(Note1)</sup> (Model for AC Analysis)	BD9E105FP4-Z_AVE

(Note 1) BD9E105FP4-Z\_AVE is the spice macro model for Frequency Characteristic (AC simulation). Refer to Page 11 to 13 for simulation detail.

### Caution

- These model characteristics are specifically at Ta = 25 °C. Thus, the simulation result with temperature variances may significantly differ from the result with the one done at actual application board (actual measurement).
- The simulation result and characteristics described in this report may differ depending on the board design. It is recommended to perform the measurement on the actual board to verify the result.
- The values from the simulation results are not guaranteed. Use these results as a guide for your design.
- Actual measurement was done using a specific sample, thus the measured data is just as a reference.

## BD9E105FP4-Z Spice Model

## ■ Pin Information

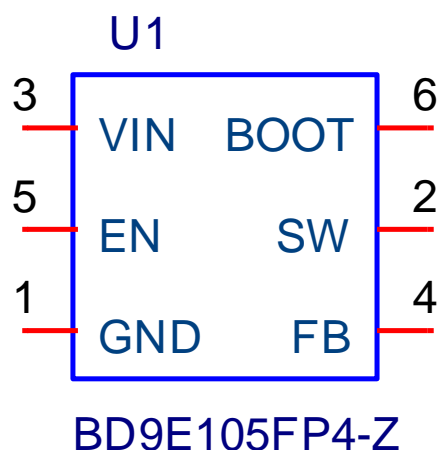


Figure 1 Symbol of BD9E105FP4-Z

Table 2 Subcircuit Pin Table

Pin No.	Pin Name	Pin No.	Pin Name
1.	GND	4.	FB
2.	SW	5.	EN
3.	VIN	6.	BOOT

## ■ Model Parameter

Table 3 Model Parameter Table

Parameter	Default Value	Description
BD9E105FP4-Z_AVE		
V_VIN	3.3	Set the VIN value. On Duty parameter for the Denominator. On Duty is given as { V_VO / V_VIN }.
V_VO	12	Set the VOUT value. On Duty parameter for the Numerator.
L	10u	Set the inductor value.

## Verifiable Characteristics

■	Electrical Characteristics (vs. Datasheet) .....	4
■	Characteristic in SPICE (vs. Measured Waveform) .....	5
➤	BD9E105FP4-Z	
✓	Output Ripple Voltage (VIN = 5 V, VOUT = 1.2 V) .....	5
✓	Output Ripple Voltage (VIN = 12 V, VOUT = 3.3 V) .....	6
✓	Output Ripple Voltage (VIN = 24 V, VOUT = 12 V) .....	7
✓	Load Response (VIN = 5 V, VOUT = 1.2 V) .....	8
✓	Load Response (VIN = 12 V, VOUT = 3.3 V) .....	9
✓	Load Response (VIN = 24 V, VOUT = 12 V) .....	10
➤	BD9E105FP4-Z_AVE	
✓	Frequency Characteristic (VIN = 5 V, VOUT = 1.2 V) .....	11
✓	Frequency Characteristic (VIN = 12 V, VOUT = 3.3 V) .....	12
✓	Frequency Characteristic (VIN = 24 V, VOUT = 12 V) .....	13

## Electrical Characteristics (vs. Datasheet)

Table 4 Electrical Characteristics Comparison

Electrical Characteristics (Unless otherwise specified Ta = 25 °C, V<sub>IN</sub> = 12 V, V<sub>EN</sub> = 3 V)

Parameter	Modeled (Note1)	Design Value		Unit	Error	Condition
		Datasheet	SPICE			
Input Supply						
Shutdown Current	Yes	3	3	μA	0%	V <sub>EN</sub> = 0 V
Operating Quiescent Current	Yes	55	55	μA	0%	I <sub>OUT</sub> = 0 A, No switching
UVLO Threshold Voltage	Yes	3.9	3.9	V	0%	V <sub>IN</sub> falling
UVLO Hysteresis Voltage	Yes	350	350	mV	0%	
Enable						
EN Threshold Voltage High	Yes	1.2	1.2	V	0%	V <sub>EN</sub> rising
EN Threshold Voltage Low	Yes	1.1	1.1	V	0%	V <sub>EN</sub> falling
EN Input Current	Yes	0	0	μA	0%	V <sub>EN</sub> = 3 V
Reference Voltage, Error Amplifier, Soft Start						
FB Threshold Voltage	Yes	0.596	0.596	V	0%	
FB Input Current	Yes	-	0	nA	-	V <sub>FB</sub> = 0.7 V
Soft Start Time	Yes	5	5	ms	0%	
SW (MOSFET)						
Switching Frequency	Yes	500	500	kHz	0%	
Maximum Duty Ratio	Yes	-	90	%	-	
High Side FET ON Resistance	Yes	165	165	mΩ	0%	V <sub>BOOT</sub> - V <sub>SW</sub> = 5 V
Low Side FET ON Resistance	Yes	95	95	mΩ	0%	
Protection						
High Side Over Current Limit	Yes	2.2	2.2	A	0%	
Low Side Over Current Limit	Yes	1.5	1.5	A	0%	

(Note 1) Yes: Model available (supported), No: Model not available (not supported).

## Characteristic in SPICE (vs. Measured Waveform)

1. Output Ripple Voltage ( $V_{IN} = 5\text{ V}$ ,  $V_{OUT} = 1.2\text{ V}$ )

## Simulation Setting

Type: Transient

Run Time: 6 ms

(Maximum Step Size: 10 ns)

## PARAMETERS:

bias = 1

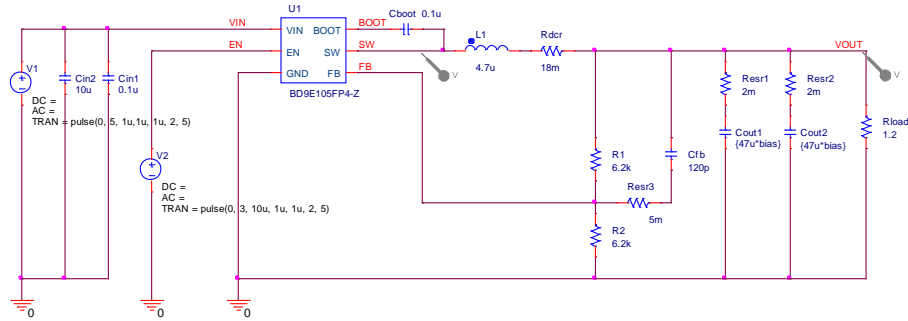
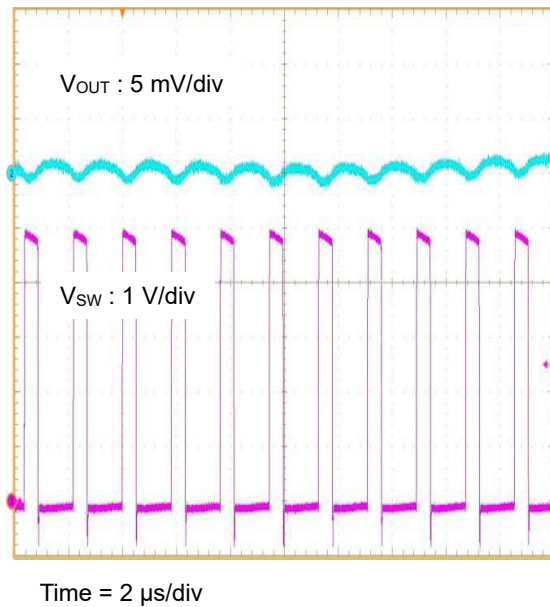
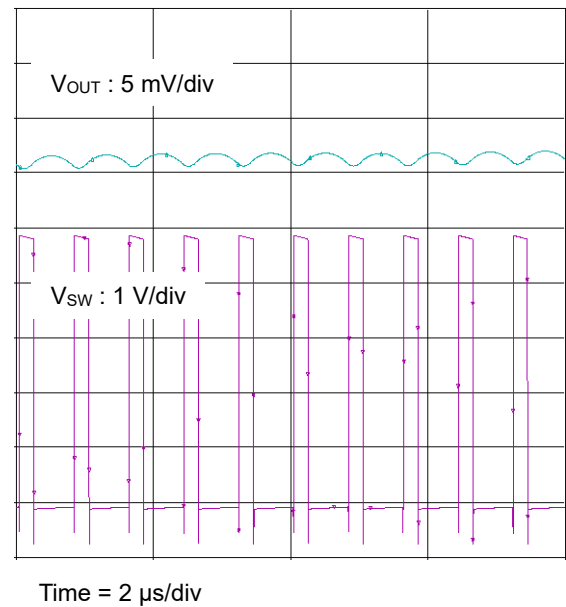
Figure 2.  
Simulation Schematic 1Figure 3.  
Output Ripple Voltage ( $V_{IN} = 5\text{ V}$ ,  $V_{OUT} = 1.2\text{ V}$ )  
(Measured Waveform)Figure 4.  
Output Ripple Voltage ( $V_{IN} = 5\text{ V}$ ,  $V_{OUT} = 1.2\text{ V}$ )  
(SPICE Simulation)

Table 5 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Output Ripple Voltage	1.5	1.2	mV	-20.0 %	$V_{IN} = 5\text{ V}$ , $V_{OUT} = 1.2\text{ V}$ , $I_{OUT} = 1\text{ A}$

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.

(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed, PCB pattern and mounting condition of each on-board parts.

2. Output Ripple Voltage (VIN = 12 V, VOUT = 3.3 V)

Simulation Setting  
Type: Transient  
Run Time: 6 ms  
(Maximum Step Size: 10 ns)

PARAMETERS:  
bias = 0.7

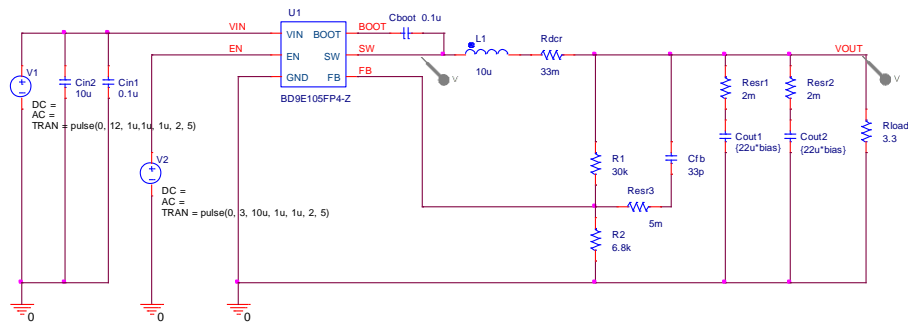


Figure 5.  
Simulation Schematic 2

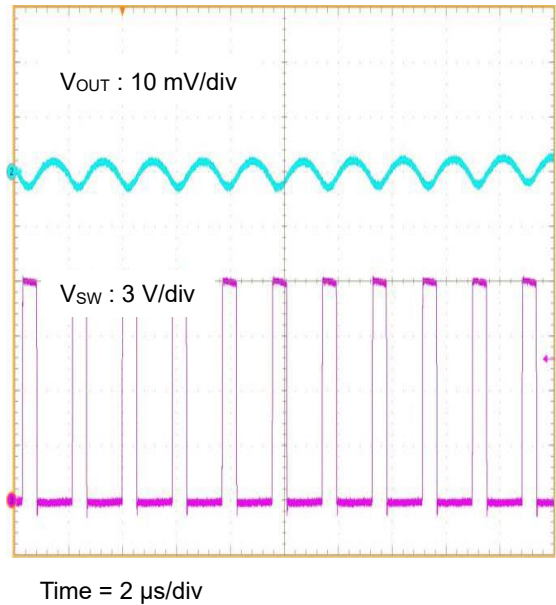


Figure 6.  
Output Ripple Voltage (VIN = 12 V, VOUT = 3.3 V)  
(Measured Waveform)

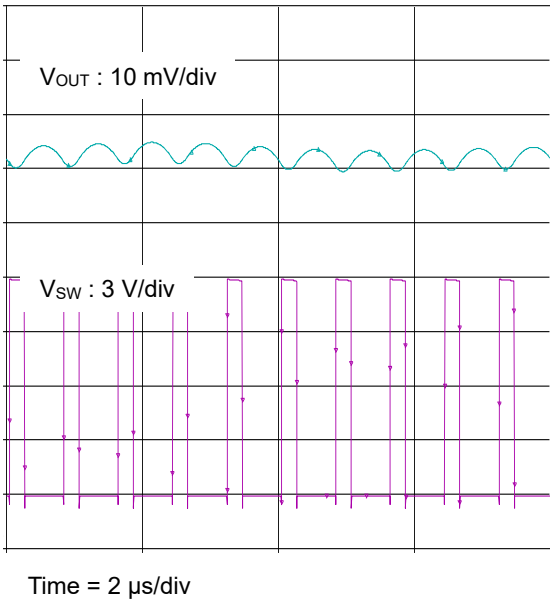


Figure 7.  
Output Ripple Voltage (VIN = 12 V, VOUT = 3.3 V)  
(SPICE Simulation)

Table 6 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Output Ripple Voltage	4.4	4.2	mV	-4.5 %	VIN = 12 V, VOUT = 3.3 V, IOUT = 1 A

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed, PCB pattern and mounting condition of each on-board parts.

3. Output Ripple Voltage (VIN = 24 V, VOUT = 12 V)

Simulation Setting  
Type: Transient  
Run Time: 6 ms  
(Maximum Step Size: 10 ns)

PARAMETERS:  
bias = 0.2

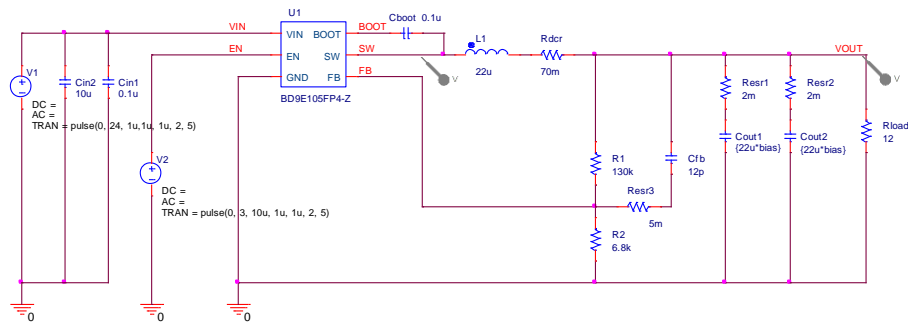


Figure 8.  
Simulation Schematic 3

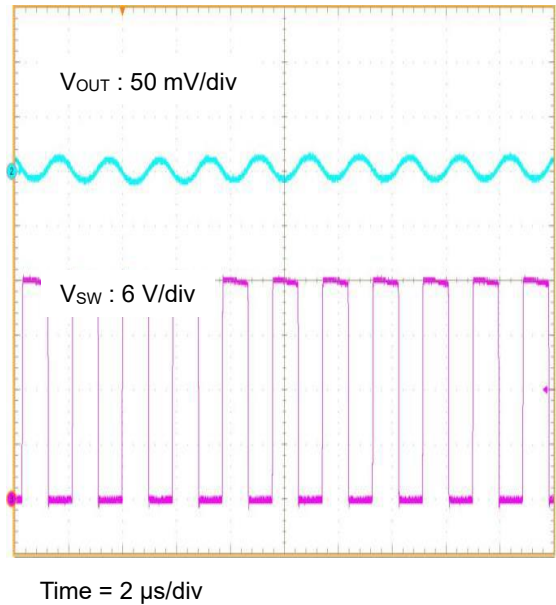


Figure 9.  
Output Ripple Voltage (VIN = 24 V, VOUT = 12 V)  
(Measured Waveform)

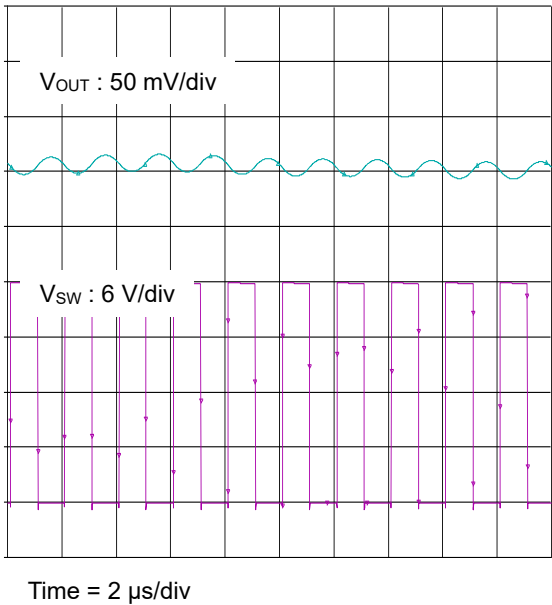


Figure 10.  
Output Ripple Voltage (VIN = 24 V, VOUT = 12 V)  
(SPICE Simulation)

Table 7 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Output Ripple Voltage	16	16	mV	0.0 %	VIN = 24 V, VOUT = 12 V, IOUT = 1 A

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed,  
PCB pattern and mounting condition of each on-board parts.

4. Load Response (VIN = 5 V, VOUT = 1.2 V)

Simulation Setting  
Type: Transient  
Run Time: 12 ms  
(Maximum Step Size: 10 ns)

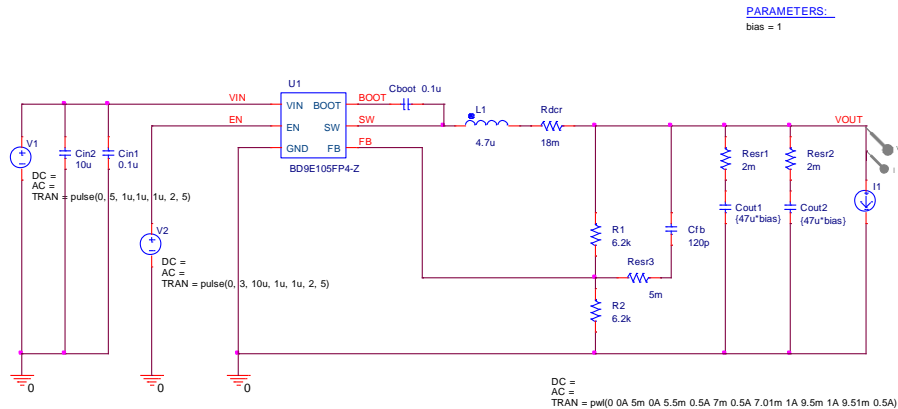


Figure 11.  
Simulation Schematic 4

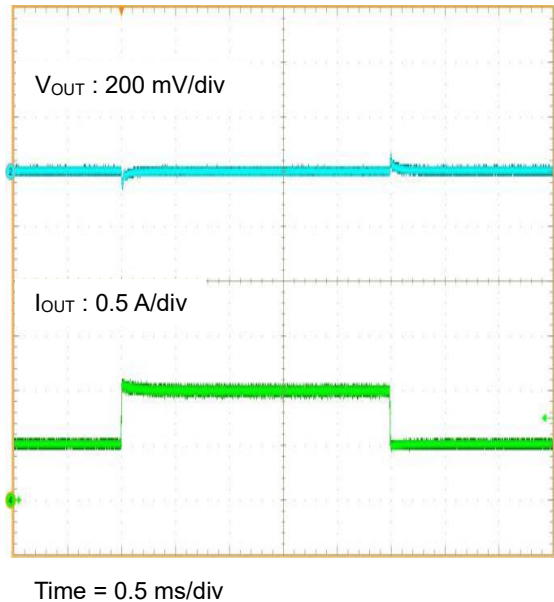


Figure 12.  
Load Response (VIN = 5 V, VOUT = 1.2 V)  
(Measured Waveform)

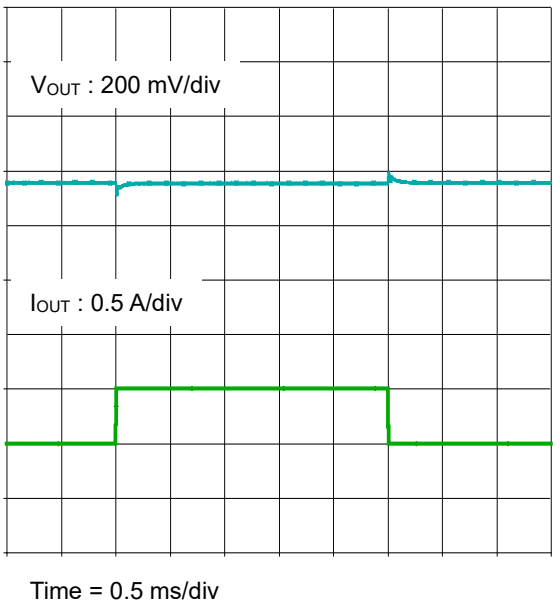


Figure 13.  
Load Response (VIN = 5 V, VOUT = 1.2 V)  
(SPICE Simulation)

Table 8 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Undershoot	22	21	mV	-4.5 %	VIN = 5 V, VOUT = 1.2 V, IOUT = 0.5 A to 1 A
Overshoot	24	25	mV	4.2 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed, PCB pattern and mounting condition of each on-board parts.



5. Load Response ( $V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 3.3\text{ V}$ )

## Simulation Setting

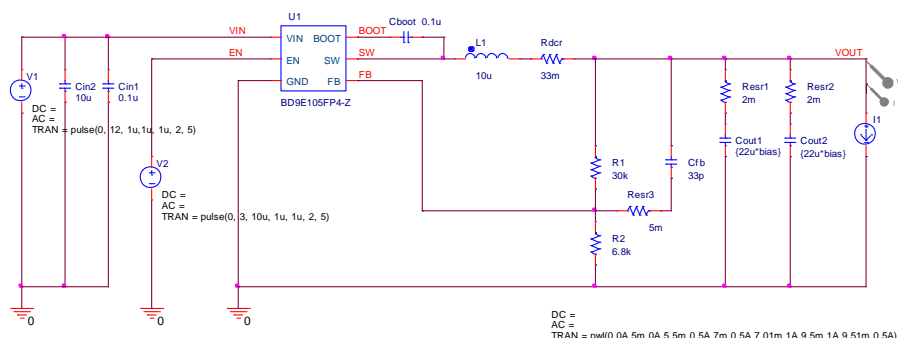
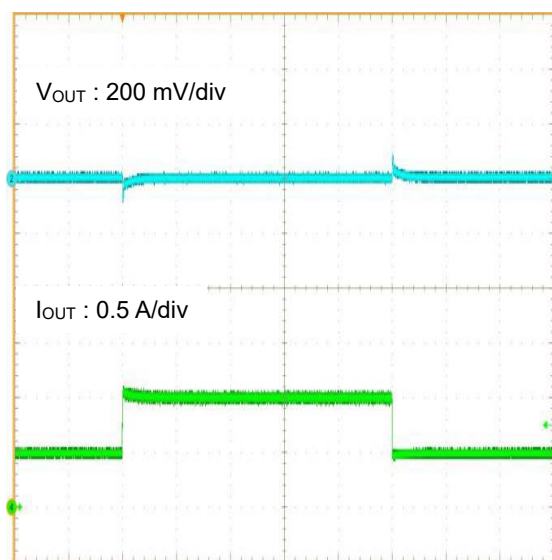
Type: Transient

Run Time: 12 ms

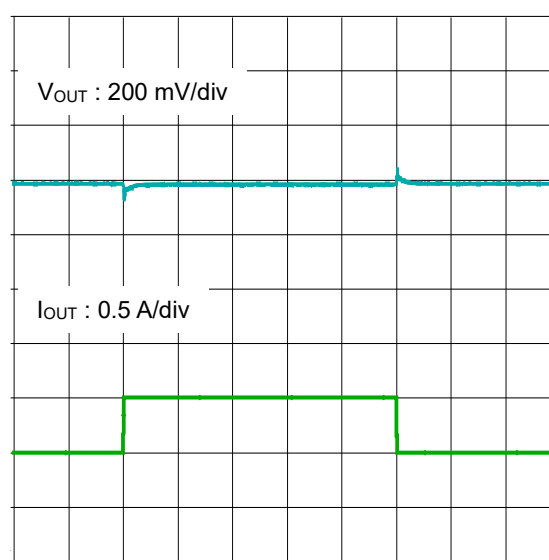
(Maximum Step Size: 10 ns)

## PARAMETERS:

bias = 0.7

Figure 14.  
Simulation Schematic 5

Time = 0.5 ms/div

Figure 15.  
Load Response ( $V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 3.3\text{ V}$ )  
(Measured Waveform)

Time = 0.5 ms/div

Figure 16.  
Load Response ( $V_{IN} = 12\text{ V}$ ,  $V_{OUT} = 3.3\text{ V}$ )  
(SPICE Simulation)

Table 9 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Undershoot	72	58	mV	-19.4 %	$V_{IN} = 12\text{ V}$ , $V_{OUT} = 3.3\text{ V}$ , $I_{OUT} = 0.5\text{ A to }1\text{ A}$
Overshoot	75	61	mV	-18.7 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.

(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed, PCB pattern and mounting condition of each on-board parts.

6. Load Response (VIN = 24 V, VOUT = 12 V)

Simulation Setting  
Type: Transient  
Run Time: 12 ms  
(Maximum Step Size: 10 ns)

PARAMETERS:  
bias = 0.2

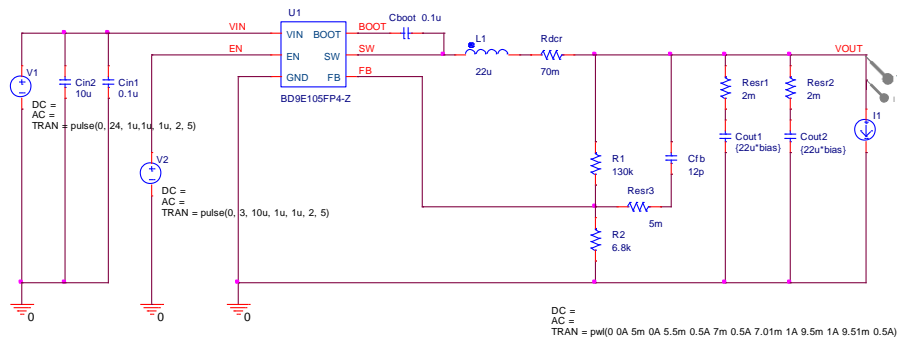


Figure 17.  
Simulation Schematic 6

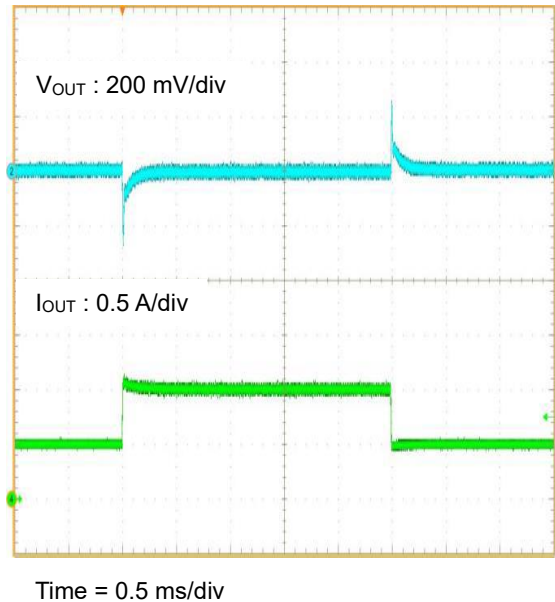


Figure 18.  
Load Response (VIN = 24 V, VOUT = 12 V)  
(Measured Waveform)

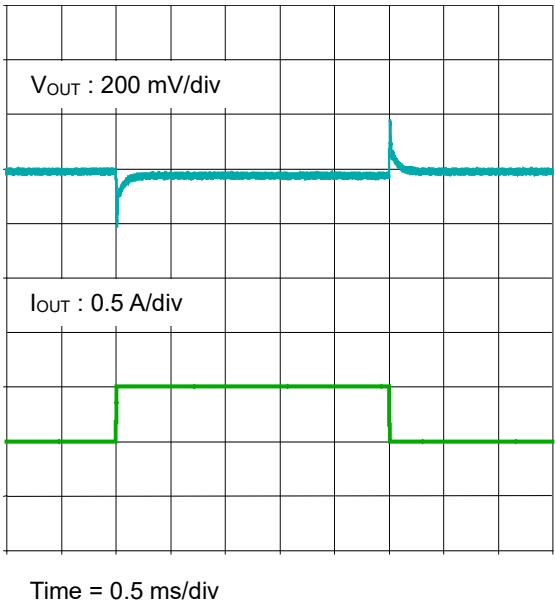


Figure 19.  
Load Response (VIN = 24 V, VOUT = 12 V)  
(SPICE Simulation)

Table 10 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Undershoot	240	202	mV	-15.8 %	VIN = 24 V, VOUT = 12 V, IOUT = 0.5 A to 1 A
Overshoot	232	188	mV	-19.0 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed, PCB pattern and mounting condition of each on-board parts.

7. Frequency Characteristic (VIN = 5 V, VOUT = 1.2 V)

Simulation Setting  
Type: AC  
Frequency Range:  
1 kHz to 1 MHz  
(Points/Decade: 20)

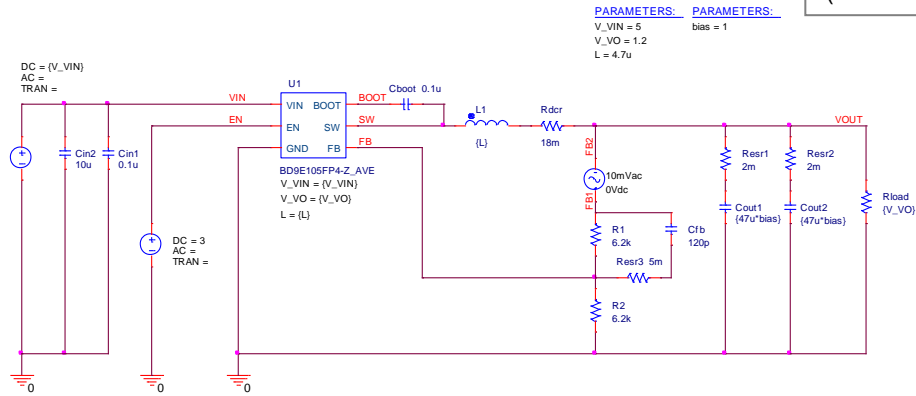


Figure 20.  
Simulation Schematic 7

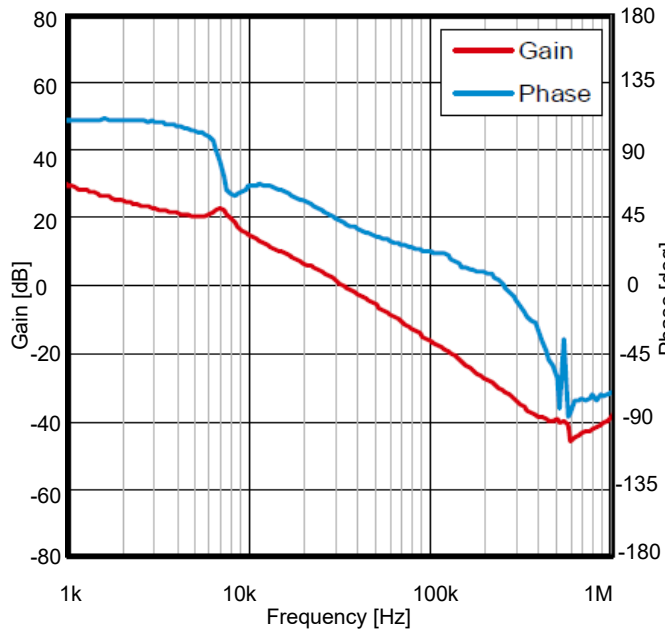


Figure 21.  
Frequency Characteristic (VIN = 5 V, VOUT = 1.2 V)  
(Measured Waveform)

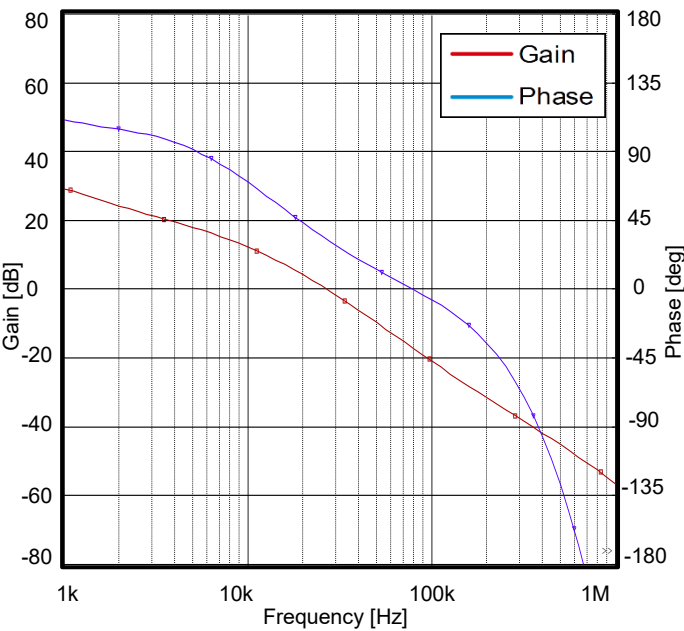


Figure 22.  
Frequency Characteristic (VIN = 5 V, VOUT = 1.2 V)  
(Measured Waveform)

Table 11 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Phase Margin	44	32.4	degree	-26.4 %	VIN = 5 V, VOUT = 1.2 V, IOUT = 1.0 A
Crossover Frequency	32	26.9	kHz	-15.9 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed,  
PCB pattern and mounting condition of each on-board parts.

8. Frequency Characteristic (VIN = 12 V, VOUT = 3.3 V)

Simulation Setting

Type: AC

Frequency Range:

1 kHz to 1 MHz

(Points/Decade: 20)

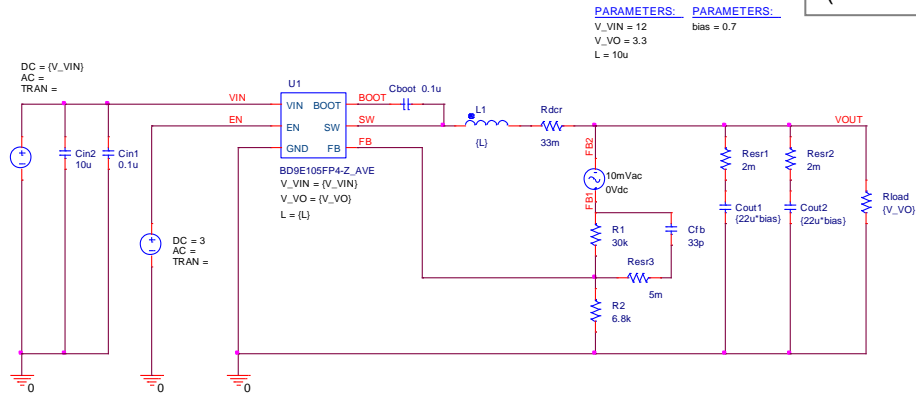


Figure 23.  
Simulation Schematic 8

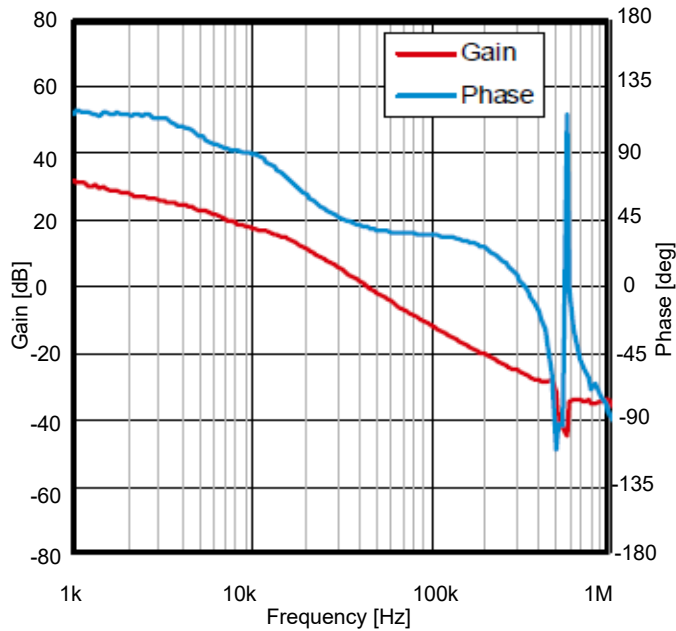


Figure 24.  
Frequency Characteristic (VIN = 12 V, VOUT = 3.3 V)  
(Measured Waveform)

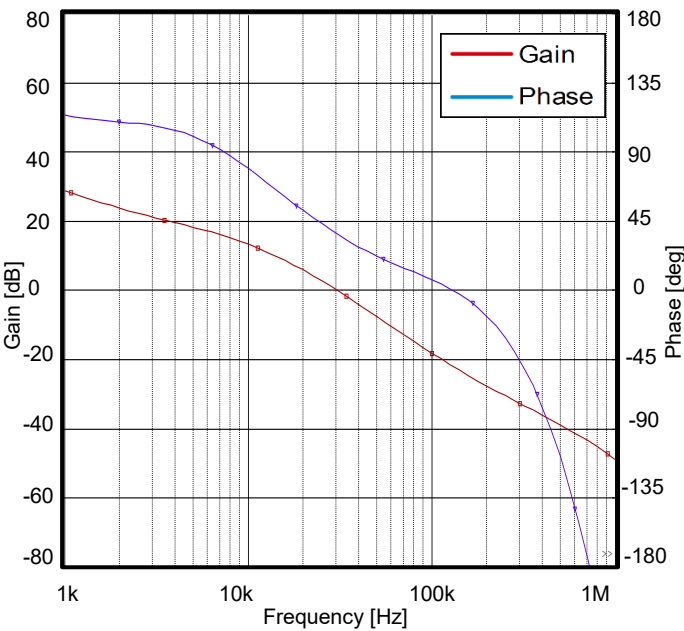


Figure 25.  
Frequency Characteristic (VIN = 12 V, VOUT = 3.3 V)  
(Measured Waveform)

Table 12 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Phase Margin	42	36.5	degree	-13.1 %	VIN = 12 V, VOUT = 3.3 V, IOUT = 1.0 A
Crossover Frequency	43	30.7	kHz	-28.6 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed,  
PCB pattern and mounting condition of each on-board parts.

9. Frequency Characteristic (VIN = 24 V, VOUT = 12 V)

Simulation Setting

Type: AC

Frequency Range:

1 kHz to 1 MHz

(Points/Decade: 20)

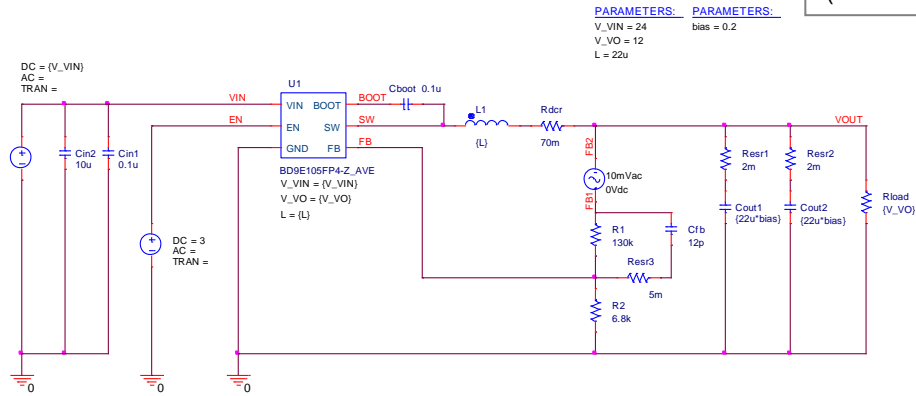


Figure 26.  
Simulation Schematic 9

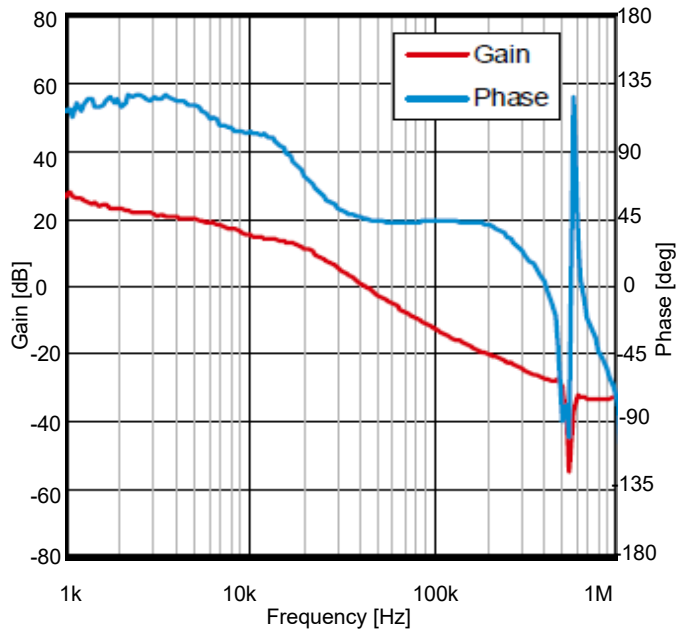


Figure 27.  
Frequency Characteristic (VIN = 24 V, VOUT = 12 V)  
(Measured Waveform)

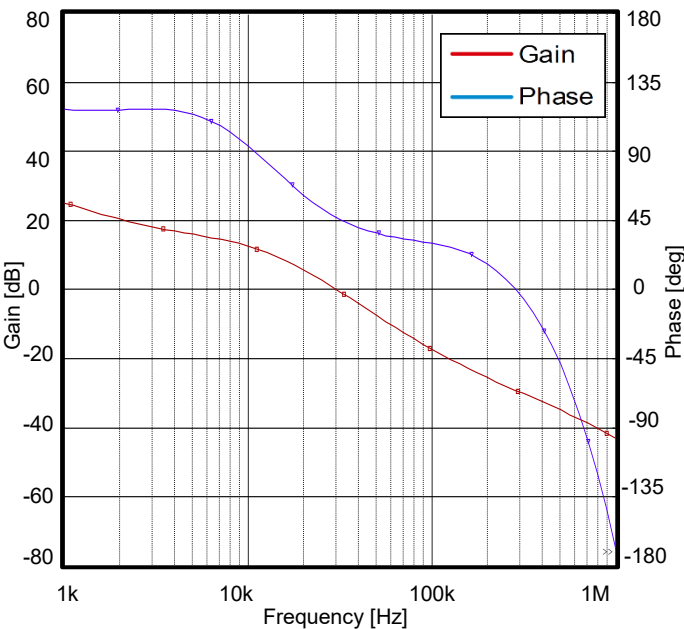


Figure 28.  
Frequency Characteristic (VIN = 24 V, VOUT = 12 V)  
(Measured Waveform)

Table 13 Characteristics Comparison

Parameter	Measured Result (Note1)(Note2)	SPICE Simulation Result	Unit	Error	Condition
Phase Margin	45	46.9	degree	4.2 %	VIN = 24 V, VOUT = 12 V, IOUT = 1.0 A
Crossover Frequency	42	30.4	kHz	-27.6 %	

(Note 1) The above data is based on a specific sample and it is not a guaranteed value.  
(Note 2) These characteristics depend on some dynamic characteristics of external components, input signal speed,  
PCB pattern and mounting condition of each on-board parts.

**Revision History**

Date	Revision	Changes
Jan.2023	001	New Release

## Notes

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